# **Molex** 75542-5000 **PDF**



深圳创唯电子有限公司 http://www.molex-

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RECEPTACLE ASSEMBLY POWER AND SIGNAL MODULE									,					NOTES:	I	i	
M =	ASSEMBLY PART NUMBER	DESCRIPTION	TRAY PART NUMBER	COVER PART NUMBER	QUANTITY PER ROW	QUANTITY PER TRAY	QUANTITY PER BOX	SCREW PACK						<ol> <li>PARTS TO BE ORIENTATED I</li> <li>PROPER ORIENTATION OF CO ON THE SURFACE OF EACH</li> </ol>	VER ONTO TRAY IS FOR TO BE IN NORMAL RE	OR THE LETTERING ADING ORIENTATION	M
	46079-1000	4 CIRCUIT MULTI-PATH	75553-3003	75553-3002	25	75	150	N/A						3. CARTON CONTAINS 2 TRAYS	- SEE CHART FOR TF	RAY QUANTITIES	
L	46079-1001	4 CIRCUIT MULTI-PATH	75553-3003	75553-3002	25	75	150	N/A						4. PACKAGING MUST MEET MOL 5. FOAM SPACERS (70892-0062	2) REQUIRED TO FILL C	DARD ES-40000-7001 PEN AREAS AT THE	L
	75542-1000	150 AMP POWER	75553-3004	75553-3002	30	90	180	N/A						ENDS OF TRAY CHANNELS.	NO FOAM REQUIRED FO	OR 75542 SERIES PART	S.
	75542-1001	150 AMP POWER	75553-3004	75553-3002	30	90	180	N/A									
ĸ	75542-5000	150 AMP POWER	75553-3004	75553-3002	30	90	180	N/A									ĸ
	75542-5001	150 AMP POWER	75553-3004	75553-3002	30	90	180	N/A									
	75545-1000	80 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									
	75545-1001	80 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									
J	75545-1100	40 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									L
	75545-1101	40 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									
_	75545-5000	80 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									
1	75545-5001	80 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									I
-	75545-5004	80 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									
-	75545-5100	40 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									
н	75545-5101	40 AMP POWER	75553-3003	75553-3002	45	135	270	N/A									н
-	75548-6000	64 CIRCUIT SIGNAL	75553-3003	75553-3002	15	45	90	N/A									
	75548-6100	64 CIRCUIT SIGNAL	75553-3003	75553-3002	15	45	90	N/A									
G	75548-6056	56 CIRCUIT SIGNAL	75553-3003	75553-3002	17	51	102	N/A									G
	75548-6156	56 CIRCUIT SIGNAL	75553-3003	75553-3002	17	51	102	N/A									
	75548-6048	48 CIRCUIT SIGNAL	75553-3003	75553-3002	19	57	114	N/A									
-	75548-6148	48 CIRCUIT SIGNAL	75553-3003	75553-3002	19	57	114	N/A									
F	75548-6040	40 CIRCUIT SIGNAL	75553-3003	75553-3002	22	66	132	N/A									F
	75548-6140	40 CIRCUIT SIGNAL	75553-3003	75553-3002	22	66	132	N/A									
-	75548-6032	32 CIRCUIT SIGNAL	75553-3003	75553-3002	26	78	156	N/A									
E	75548-6132	32 CIRCUIT SIGNAL	75553-3003	75553-3002	26	78	156	N/A									E
-	75548-6024	24 CIRCUIT SIGNAL	75553-3003	75553-3002	32	96	192	N/A									
	75548-6124	24 CIRCUIT SIGNAL	75553-3003	75553-3002	32	96	192	N/A									
D	75552-5001	ALIGNER MODULE	75553-3003	75553-3002	30	90	180	73774-7030									D
-	75552-5002	ALIGNER MODULE	75553-3003	75553-3002	30	90	180	73774-7031									
				C													
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										60				DIMENSION STYLE	SCALE DESIGN UNITS		
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Μ		М
L	FOAM PAD	L
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J	RECEPTACLE ASSEMBLY MODULES SEE CHART FOR PART NUMBER AND QUANTITIES SEE CHART (2) SEE NOTE 2 SEE NOTE 2	J
I		Ι
Н	SHIPPING CARTON 46461-0001 TRAY, THERMO-FORMED SFE CHART (2) FOAM SPACER 70892-0062	Н
G	SEE NOTE 5	G
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#### EXTREME POWERMASS VERTICAL RECEPTACLE INSTALLATION SPECIFICATION

#### 1.0 SCOPE

This specification applies to the series 75541 Extreme Powermass vertical receptacle products with press-fit tails.

#### 2.0 PRODUCT DESCRIPTION

The Extreme Powermass system consists of 150 amp, 80 amp, High Voltage 40 amp, and Signal modular configurations. The vertical receptacle connectors are through-hole devices with eye-of-theneedle compliant pin terminals. The connector assembly is delivered with the modules pre-installed on an alignment "rail" system that aligns and support the modules during the press-fit operation. The rail provides a flat top surface to press with flat rock press during installation so that no specialized tooling is needed. The rail and an accompanying plate must be removed after installation and before connector mating.

#### 3.0 REFERENCE DOCUMENTS

- 3.1 Refer to the appropriate sales or manufacturing drawing for information on dimensions, materials, plating, and markings.
- 3.2 PS-75431-999 Extreme Powermass Product Specification.
- 3.3 ATS-622022200 Extreme Powermass Rail Removal Tool Instruction Sheet

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#### 5.0 PRINTED CIRCUIT BOARD SUPPORT

The Powermass connector requires up to 25 lb. per pin of force to press the connectors into the printed circuit boards. Therefore, a backup or support fixture is required to prevent damage to the PCB. The support fixture should have clearance for the connector terminals when they protrude through the underside of the PCB. It is also recommended that the support fixture have locating pins. Due to the custom nature of each application, Molex does not supply support and locating fixtures, the customer normally supplies them.

The following is one simple way of making a PCB support and locating fixture:

- 5.1 Locate a suitable piece of material for the backup. It should be approximately <sup>3</sup>/<sub>4</sub> inch thick and the same size or slightly larger than the PCB to be used. While aluminum can be used, a rigid nonconductive material such as a phenolic is preferred. (A stack of scrap PCBs of suitable size can be fastened together and used as a fixture).
- 5.2 Obtain a scrap PCB like the ones to be assembled. Attach this PCB to the material from step 5.1.
- 5.3 Using an oversize drill bit, drill through each hole where a pin from the connector will go. Drill deep enough into the lower material to be certain the pins do not bottom out when inserted (at least 5mm [0.20in] deep).
- 5.4 Locate two (2) holes on the PCB to use as locating points. Drill for and mount suitably sized dowel pins in the two locations on the support fixture.
- 5.5 Clear out the support for any components mounted on the underside of the PCB.

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### 6.0 INSTALLATION PROCEDURE

- 6.1 Be certain the correct application tooling and board support are clean of debris or any other material that could damage the connector or PCB.
- 6.2 Place the board support under the ram of the press. Note: Be certain the board support is square and sits level on the press; this is important due to the high forces generated during the press in process. Any flexing during the press in process could damage the board support, PCB, connector or the application tooling. The board support must provide clearance to all press-fit tails.
- 6.3 Program the press (if applicable) for the optimum force necessary to fully seat the connector on the PCB. Consult the Powermass product spec for recommended insertion force.
- 6.4 Place the printed circuit board on the board support. Note: The PCB should be doweled to the board support so no shifting occurs during the press in process that will cause mis-alignment between the PTH and the clearance holes in the board support.
- 6.5 Before placing the connector on the PCB inspect for any bent pins that would interfere with proper alignment to the PCB. Refer to workmanship criteria for descriptions and examples of product defects.
- 6.6 Place the connector on the PCB.
- 6.7 Place the insertion tool on the connector.
- 6.8 Cycle the press to seat connector on the PCB.
- 6.9 Check that connector is fully seated on the PCB and that all compliant tails were pressed in without any bent pins. See Figure 6.1.





#### 8.0 RAIL REMOVAL PROCEDURE

After the connector is pressed on the PCB and the aligners screws are installed, remove the rail using the Powermass rail removal tool. See Figures 8.1 through 8.3. See Powermass Rail Removal Tool Instruction Sheet for detailed tool operation instructions.







#### 9.0 INSPECTION PROCEDURE (POST INSTALLATION)

After the connector is pressed on the PCB the final assembly should be inspected. The following is a recommended inspection procedure.

First, inspect the mating side of the connector

- \* The plastic shroud should be seated and flush to the PCB, a maximum allowable gap of 0.13mm is acceptable (see figure 8.1).
- \* If the seating height is not correct connectors may be repressed to obtain the correct seating height.
- \* Inspect the plastic housing, verify it is not cracked, deflected or damaged in any way. To avoid a mis-mate condition the daughtercard lead-in zone must be free of debris and not damaged in any way.

Second, inspect the bottom side of the PCB

\* Verify all pins were pressed into the PTH's, if a pin did not get pressed into a hole the most common cause for this condition is mis-loading of the connector.

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